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2014年9月

FCPF7N60NT

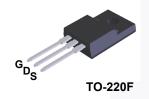
N 沟道 MOSFET 600 V, 6.8 A, 0.52 Ω

特性

- Typ R_{DS(on)} = 460 m Ω
- 超低栅极电荷 (典型值 Q_q = 17.8 nC)
- 低有效输出电容 (典型值 C_{oss(eff.)}= 91 pF)
- 100% 经过雪崩测试
- 符合 RoHS 标准

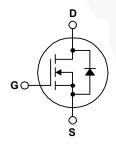
应用

- 太阳能逆变器
- AC-DC 电源



描述

SupreMOS[®] MOSFET 是飞兆半导体的下一代高压超级结(SJ)技术,该技术采用区别于传统 SJ MOSFET 产品的深沟槽填充工艺。这项先进技术和精密的工艺控制提供了最低的导通电阻,卓越的开关性能和耐用性。 SupreMOS MOSFET 产品适用于高频开关电源转换器应用,如功率因数校正 (PFC)、服务器/电信电源、平板电视电源、ATX 电源及工业电源应用等。



MOSFET 最大额定值 T_C = 25℃ 除非另有说明。

符号		参数			单位
V_{DSS}	漏极一源极电压			600	V
V_{GSS}	栅极一源极电压			±30	V
	足机中次	- 连续 (T _C = 25°C)		6.8*	A
ID	漏极电流	- 连续 (T _C = 100°C)		4.3*	
I _{DM}	漏极电流	- 脉冲	(注 1)	20.4	Α
E _{AS}	单脉冲雪崩能量		(注2)	79.4	mJ
I _{AR}	雪崩电流			6.8	Α
E _{AR}	重复雪崩能量			0.6	mJ
dv/dt	MOSFET dv/dt 强度			100	V/ns
av/at	二极管恢复 dv/dt 峰值		(注3)	4.9	V/ns
В	-1. ±1	(T _C = 25°C)		30.5	W
P_{D}	功耗	- 高于 25°C 的功耗系数		0.24	W/°C
T _J , T _{STG}	工作和存储温度范围			-55 to +150	°C
TL	用于焊接的最大引脚温度,	距离外壳 1/8",持续 5 秒		300	°C

^{*}漏极电流受限于最大结温。

热性能

符号	参数	FCPF7N60NT	单位
$R_{\theta JC}$	结至外壳热阻最大值	4.1	°C/M
$R_{\theta JA}$	结至环境热阻最大值	62.5	°C/W

封装标识与定购信息

器件标识	器件	封装	卷尺寸	带宽	数量
FCPF7N60NT	FCPF7N60NT	TO-220F	-	-	50

电气特性 T_C = 25°C 除非另有说明。

符号	参数	测试条件	最小值	典型值	最大值	单位
关断特性						
BV _{DSS}	漏极一源极击穿电压	I _D = 1 mA, V _{GS} = 0 V, T _C = 25°C	600	-	-	V
ΔBV _{DSS} / ΔT _J	击穿电压温度系数	I _D = 1 mA, 参考 25°C 数值	-	0.6	-	V/°C
1	零栅极电压漏极电流	V _{DS} = 480 V, V _{GS} = 0 V	-	-	10	^
IDSS	冬伽似电压	V_{DS} = 480 V, V_{GS} = 0 V, T_{C} = 125°C	-	-	100	μΑ
I_{GSS}	栅极 - 体漏电流	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	±100	nA

导通特性

V _{GS(th)}	栅极阈值电压	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2.0	-	4.0	V
R _{DS(on)}	漏极至源极静态导通电阻	$V_{GS} = 10 \text{ V}, I_D = 3.4 \text{ A}$	-	0.46	0.52	Ω
g _{FS}	正向跨导	$V_{DS} = 20 \text{ V}, I_{D} = 3.4 \text{ A}$	-	8.5	-	S

动态特性

C _{iss}	输入电容	V = 400 V V = 0 V	-	719	960	pF
Coss	输出电容	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$ f = 1 MHz	-	30	40	pF
C _{rss}	反向传输电容	1 171112	-	2.1	3.2	pF
C _{oss}	输出电容	$V_{DS} = 380 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	- \	17	-	pF
C _{oss} eff	有效输出电容	$V_{DS} = 0 \text{ V to } 380 \text{ V}, V_{GS} = 0 \text{ V}$	- \	91	-	pF
Q _{g(tot)}	10 V 电压的栅极电荷总量	$V_{DS} = 380 \text{ V}, I_{D} = 3.4 \text{ A}$	-	17.8	35.6	nC
Q_{gs}	栅极 - 源极栅极电荷	V _{GS} = 10 V	-	3.2	6.3	nC
Q_{gd}	栅极 - 漏极 " 米勒 " 电荷	(注 4)	-	6.0	11.9	nC
ESR	等效串联电阻 (G-S)	漏极开路 , f = 1MHZ	-	2.5	-	Ω

开关特性

t _{d(on)}	导通延迟时间		-	12	24	ns
t _r	导通上升时间	$V_{DD} = 380 \text{ V}, I_D = 3.4 \text{ A}$	-/	6	22	ns
t _{d(off)}	关断延迟时间	$R_G = 4.7 \Omega$	-	35	80	ns
t _f	关断下降时间	(注4)	//-	12	24	ns

漏极 - 源极二极管特性

I _S	漏极 - 源极二极管最大正向连续电流	漏极 - 源极二极管最大正向连续电流		-	6.8	Α
I_{SM}	漏极 - 源极二极管最大正向脉冲电流	漏极 - 源极二极管最大正向脉冲电流		-	20.4	Α
V_{SD}	漏极 - 源极二极管正向电压	$V_{GS} = 0 \text{ V}, I_{SD} = 3.4 \text{ A}$	-	-	1.2	V
t _{rr}	反向恢复时间	$V_{GS} = 0 \text{ V}, I_{SD} = 3.4 \text{ A}$	-	211	-	ns
Q _{rr}	反向恢复电荷	$dI_F/dt = 100 A/\mu s$	-	1.8	-	μС

注:

- 1. 重复额定值:脉冲宽度受限于最大结温。
- 2. I_{AS} = 12 A, V_{DD} = 50 V, R_G = 25 Ω , 开始于 T_J = 25°C。
- 3. $I_{SD} \le$ 36 A, di/dt \le 200 A/ μ s, V_{DD} = 380 V 开始于 T_J = 25°C。
- 4. 典型特性本质上独立于工作温度。

典型特性

图 1. 导通区域特性

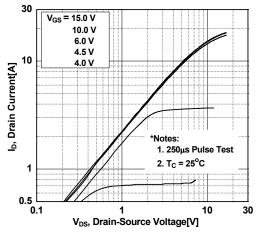


图 3. 导通电阻变化与漏极电流和栅极电压的关系

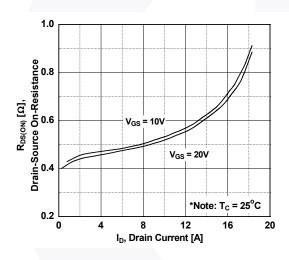


图 5. 电容特性

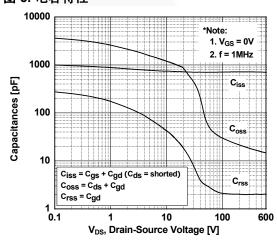


图 2. 传输特性

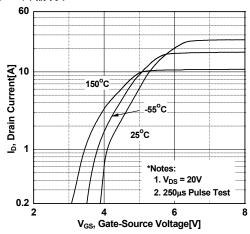


图 4. 体二极管正向电压变化与源极电流和温度的关系

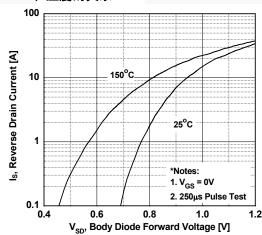
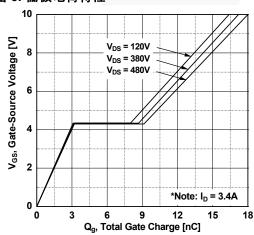


图 6. 栅极电荷特性



典型特性 (接上页)

图 7. 击穿电压变化与温度的关系

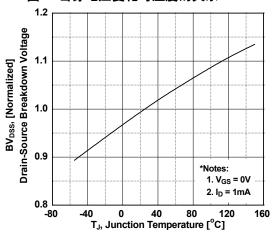


图 8. 导通电阻变化与温度的关系

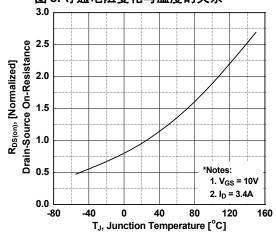


图 9. 最大安全工作区 _ FCPF7N60NT

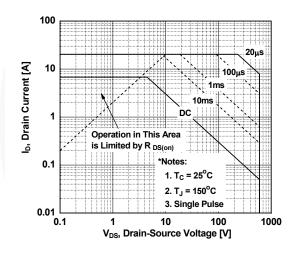
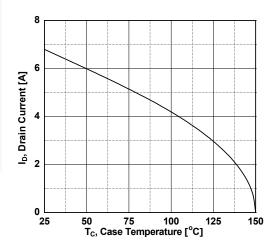


图 10. 最大漏极电流与壳温的关系



典型特性 (接上页)

图 11. 瞬态热响应曲线 _ FCPF7N60NT

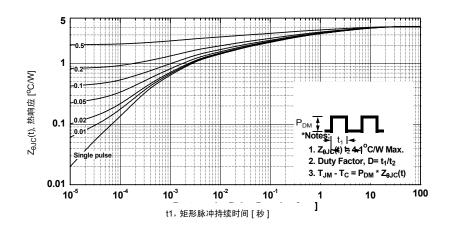


图 12. 栅极电荷测试电路与波形

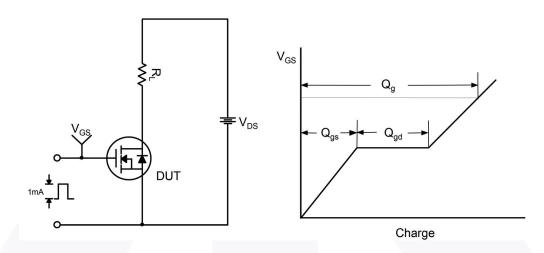


图 13. 阻性开关测试电路与波形

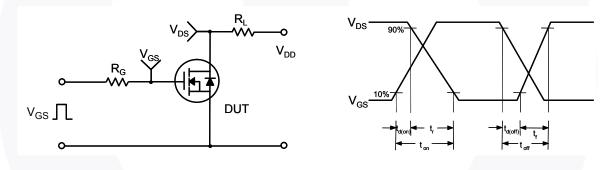
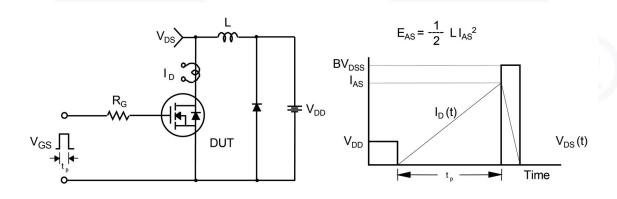
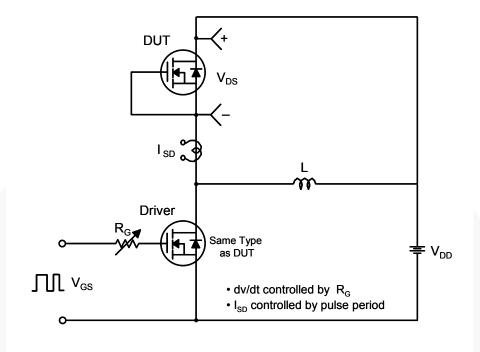
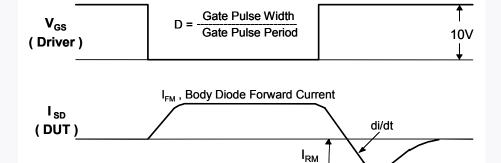


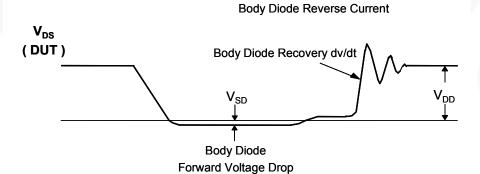
图 14. 非箝位感性开关测试电路与波形











机械尺寸

TO-220F 3L

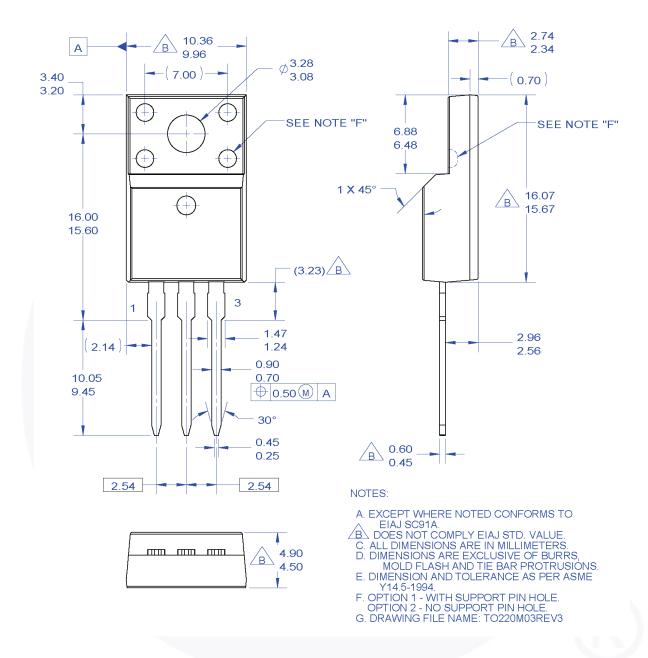


图 16. TO220,模塑, 3 引脚,全封装, EIAJ SC91,直引脚

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